

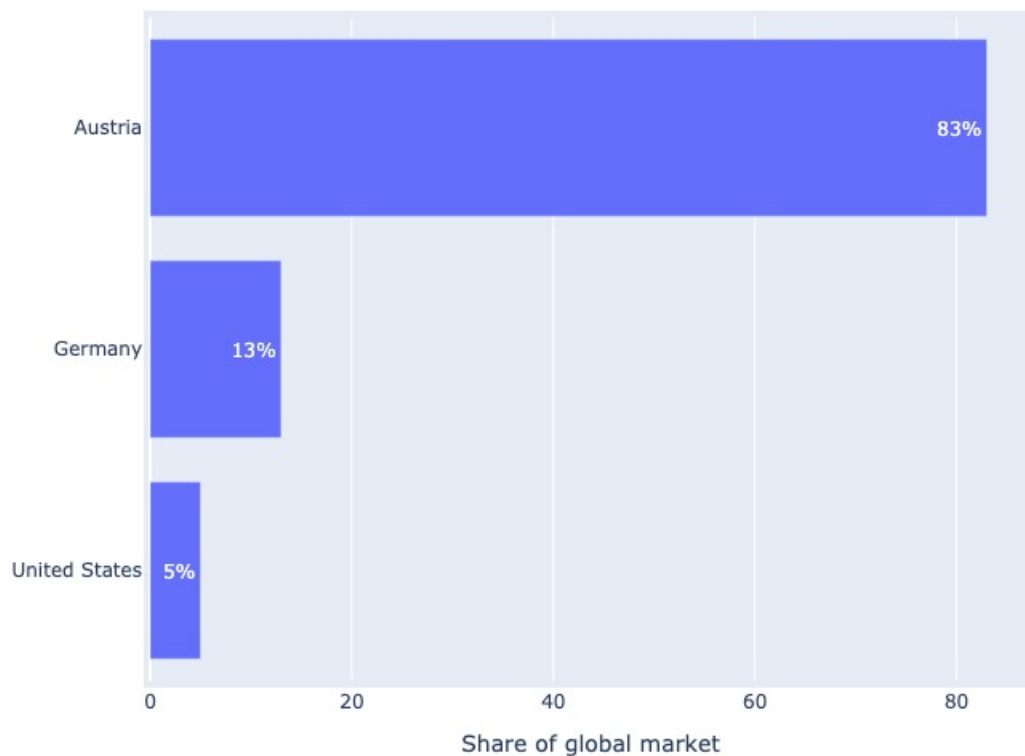
Supply Chain Explorer: Wafer bonding and aligning tools

This is an export from the Emerging Technology Observatory **Supply Chain Explorer** (<https://chipexplorer.eto.tech>). You can see the web version of this content at <https://chipexplorer.eto.tech/?filter-choose=input-resource&input-resource=N10>.

Wafer bonding and aligning tools

Wafer bonders and aligners join silicon wafers. In this visualization, these tools are included as an input to producing wafers, but they may also be used later in the production process, after chips are fabricated in the wafers. Austria, Germany, and the United States produce this equipment.

Supplier countries



Other providers:

- China (mainland) (negligible)

Notable supplier companies

- EV Group - Austria
- Neutronix - United States
- SMEE (negligible market share) - China (mainland)
- SUSS MicroTec - Germany